

PRODUCT SPECIFICATION

Model No: BOS-2835-2YC

Descriptions:

Miniature Surface Mounted Top View LED

Upward-lighting And Surface Mounted Type (PLCC-2 Package)

Emitting Color : YELLOW

Viewing Angle : 120°





CUSTOMER APPROVED SIGNATURES	APPROVED BY	CHECKED BY	PREPARED BY
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■ Features

• Yellow type.

• Dimensions: $3.5(L)\times2.8(W)\times0.7(H)$ mm,

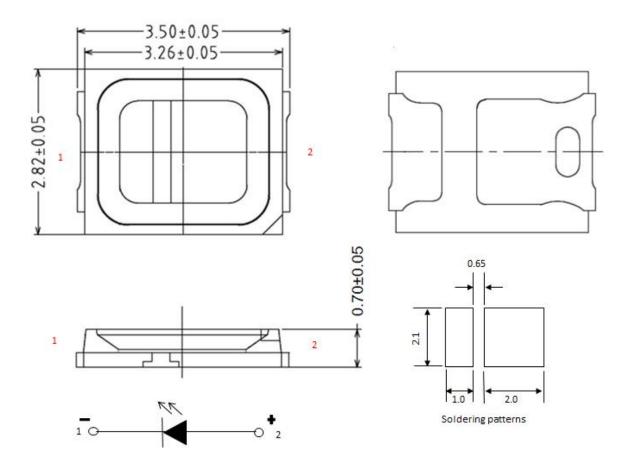
■ Applications

•Exterior Automotive Lighting,

■ Device Selection Guide

Model No.	Chip		Epoxy Color	
Widdel No.	Material	Emitting Color	Lpoxy color	
BOS-2835-2YC	AlGaInP	Yellow	Water Clear	

■ Package Outline Dimensions



NOTE: All dimensions in mm tolerance is ±0.1mm unless otherwise noted.

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■ Absolute Maximum Ratings(Ta=25° C)

Items	Symbol	Absolute Maximum Ratings	Unit	
Power Dissipation	P _d	500	mW	
Forward Current(DC)	I _F	200	mA	
Peak Forward Current*	I _{FP}	300	mA	
Reverse Voltage	V _R	5	V	
Operation Temperature	T _{opr}	-40 ~~ +110	°C	
Storage Temperature	T _{stg}	-40 ~~ +110	°C	
50% Power Angle	201/2	100 ~110 ~120	deg	
Thermal resistance	Rth	35	k/w	
Junction Temperature	Tj	125	°C	
Electrostatic Discharge	ESD	2000	V	
Soldering Temperature	T _{sol}	260°C for 5 Seconds		

^{*}Pulse Width ≤ 0.1 msec and Duty $\leq 1/10$

■Typical Electrical & Optical Characteristics (Ta=25°C)

Items	Symbol	Condition	Min.	Тур.	Max.	Unit
Forward Voltage	V_{F}	I _F =150mA		2.2		V
Dominant Wavelength	Wd	I _F =150mA		590		nm
Luminous Intensity	l _V	I _F =150mA		20		lm
Reverse Current	I _R	V _R =5V			1	μA

Code

2G

2H

■ Luminous Intensity Rank Limits(IF =150mA)

Max

20

24

Unit

lm

Min

16

20

■ Forward Voltage Rank Limits (IF =150mA)

Code	Min	Max	Unit	
C5	2.0	2.15		
D5	2.15	2.3	T.	
E5	2.3	2.45	V	
F5	2.45	2.6		

■ Dominant Wavelength Rank Limits (IF =150mA)

Code	Min	Max	Unit	
YA	584	588	10.100	
YB	588	592	nm	

Notes: 1.Tolerance of measurement of forward voltage is ± 0.05V;

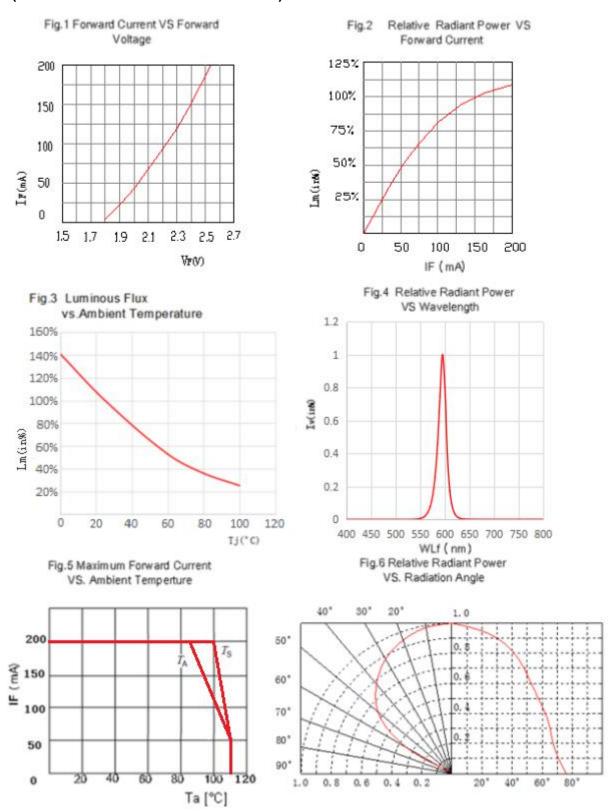
- 2. Tolerance of measurement of luminous intensity is ±10%;
- 3. Tolerance of measurement of dominant wavelength is ±1.0nm

NOTE: For long-term performance, the drive currents between 5 mA and 200 mA are recommended. If the the drive currents is different with our condition ,Please contact our customer service.

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■ Typical Electrical / Optical Characteristics Curves (Ta = 25°C Unless Otherwise Noted)



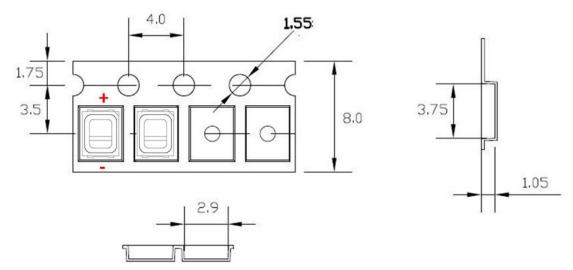
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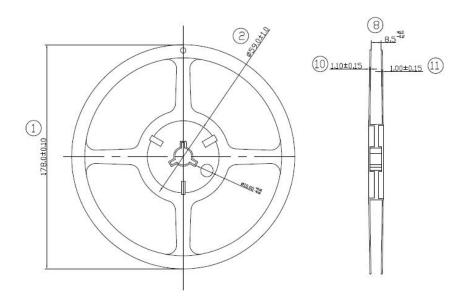


■ Packing Specification

1. Packing Type: Reel and Anti-electrostatic Bag

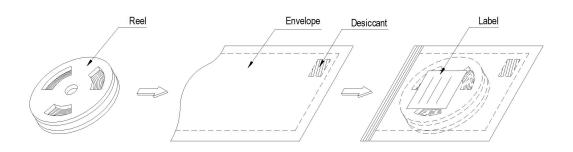
2. Packing Standard Quantity: 3000pcs/Reel, 30kpcs/box. Note: The same Rank LED should be in the same box.





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3. Label Form









BOS-2835-2YC

LOT NO: Q'ty(pcs)

LX (1m): CUST. P/N: WD(nm): 拆封时间: 使用时间:

Made in China QA Date:

Notes:

SAP NO :SAP number LOT NO: LOT number VF(V):Forward Voltage LX(Im):Luminous Intensity

WD(nm):Dominant Wavelength

Q'ty(Pcs): Total of LED

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■ Reliability

1) Test Items and Results:

Classifi- cation	Test Item	Standard Test Method	Test Conditions	Duration	Units Tested	Number Of Damaged
Life Test	Operating Life Test	JIS7021:B4 MIL-STD-202:107D MIL-STD-750:1026	Ta=85℃ ±5℃,IF=200mA	1000 Hrs	22	0/22
	High Temperature Storage	JIS7021:B10 MIL-STD-202:210A MIL-STD-750:2031	Ta=110℃±5℃	1000Hrs	22	0/22
.	Low Temperature Storage	JIS7021:B12	Ta=-40℃±5℃	1000Hrs	22	0/22
Environment Test	Temp. & Humidity Test	JIS7021:B11 MIL-STD-202:103D	Ta=85℃±5℃ RH=85%±5%RH	1000Hrs	22	0/22
Environ	Thermal Shock Test	JIS7021B4 MIL-STD-202:107D MIL-STD-750:1026	-40°C±5°C ← → 125°C±5°C 15min 10S 15min	1000 Cycles	22	0/22
	ESD	JESD22 A-114	±2KV	5 times	22	0/22
Soldering Test	Resistance to soldering		Tsol=260±5 ℃, 5sec	2 times	22	0/22

2) Criteria for Judge The Damage:

Items	Symbol Condition		Criteria for Judge		
items	Symbol	Condition	Min.	Max.	
Forward Voltage	VF	I _F =200mA		initial value x 1.1	
Reverse Current	I _R	V _R =5V		initial value x 1.1	
Luminous Intensity	l _V	I _F =200mA	initial value x 0.8		

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■Precautions For Use

1. Over -current -proof

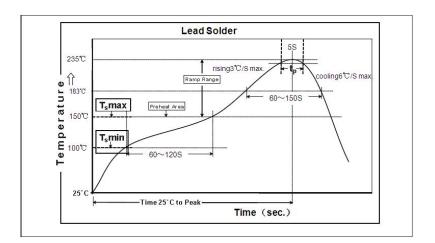
Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen)

2. Storage Caution

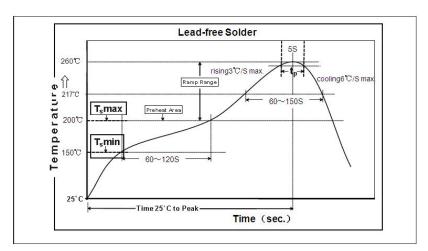
- 2.1 The storage condition in sealed bags: at 5-35 $\,^{\circ}$ C and <70% relative humidity.
- 2.2 After bags are opened, the devices must be mounted within 168 hrs at <60% relative humidity.
- 2.3 It will be better to bake all devices before soldering.
- 2.4 Devices must be baked before mounting, if
 - A, the color of humidity indicator card at point ">30%" is pink (the original color is blue);
 - B, bags are opened over 168 hrs.
 - C. the stroge time (begin with QA date) is over 1 year.
- 2.5 The bake condition: 24 hrs at 65°C \pm 5 °C (12-48 hrs will be available if 24 is not suitable)

3.Reflow Soldering / Time

3.1 Lead Solder/Time



3.2 Lead-free Solder/Time



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4.Soldering Iron

- 4.1 When hand soldering, keep the temperature of iron below less 300 ℃ less then 3 seconds
- 4.2 The hand solder should be done only one times
- 4.3 The basic spec is \leq 5 sec. when the temperature of 260°C, do not contact the resin when hand soldering

5. Rework

- 5.1. Customer must finish rework within 5 sec. under 260°C
- 5.2. The head of iron can not touch the resin
- 5.3. Twin-head type is preferred.

6.Control method of LED devices Usage

- 6.1.Before baking, it is necessary to fill in the baking form that including detail information such as model and lot number of devices, starting and ending time of baking, operators, etc. Devices that have longest dehumidify time should be used previously for those baked over 24 hrs. LED products that will not use immediately should be vacuum sealed when the baking time is almost 72hrs. Devices must be baked before next soldering.
- 6.2. The baked devices must be mounted within 168 hrs. After 168 hrs, it needs to be re-baked before soldering.
- 6.3.The soldering interval should be less than 24hrs if the PCB with devices will be SMT for two times. PCB with devices must be baked 24 hrs at 65 ± 5 $^{\circ}\mathrm{C}$ if the interval of two SMT is between 24hrs and 48hrs. Or PCB with devices must be baked 12 hrs at 100 $^{\circ}\mathrm{C}$ to 125 $^{\circ}\mathrm{C}$ if the interval of two SMT is between 24hrs and 48hrs.

7. Caution in ESD

- 7.1 Electrostatic discharge (ESD) and surge current (EOS) can damage LEDs.
- 7.2 An ESD wrist strap, ESD shoe strap or antistatic gloves must be worn whenever handling LEDs
- 7.3 All devices equipment and machinery must be properly grounded.

8.RESTRICTIONS ON PRODUCT USE

- The information contained herein is subject to change without notice.
- BYD Semiconductor Company Limited exerts the greatest possible effort to ensure high quality and reliability. Nevertheless, semiconductor devices in general can malfunction or fail due to their inherent electrical sensitivity and vulnerability to physical stress. It is the responsibility of the buyer, when utilizing products, to comply with the standards of safety in making a safe design for the entire system, including redundancy, fire-prevention measures, and malfunction prevention, to prevent any accidents, fires, or community damage that may ensue. In developing your designs, please ensure that products are used within specified operating ranges as set forth in the most recent products specifications.

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■ The products listed in this document are intended for usage in general electronics applications (computer, personal equipment, office equipment, measuring equipment, industrial robotics, domestic appliances, etc.). These products are neither intended nor warranted for usage in equipment that requires extraordinarily high quality and/or reliability or a malfunction or failure of which may cause loss of human life or bodily injury ("Unintended Usage"). Unintended Usage include atomic energy control instruments, airplane or spaceship instruments, transportation instruments, traffic signal instruments, combustion control instruments, medical instruments, all types of safety devices, etc.. Unintended Usage of products listed in this document shall be made at the customer's own risk.

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